HannStar HannStar Display Corp.

Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	1/25
Document No.		Revision	1.0

TO: Chinachip

Date: 2008/09/30

# **Customer Acceptance Specification**

Model: HSD070I651

-F01

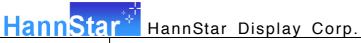
Accepted by:	
Signature	Date
Proposed by: Technical Service D	Division
Signature	Date

Note:1. Please contact HannStar Display Corp. before designing your product based on this module specification.

2.The information contained herein is presented merely to indicate the characteristics and performance of our products. No responsibility is assumed by HannStar for any intellectual property claims or other problems that may result from application based on the module described herein.

Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	2/25
Document No.		Revision	1.0

Record of Revisions						
Rev.	Rev. Date Sub-Model Description of change					
1.0	2008/09/30	F01	Formal Product Specification was first issued.			



Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	3/25
Document No.		Revision	1.0

# Contents

1.0	General description	p.4
2.0	Absolute maximum ratings	p.5
3.0	Optical characteristics	p.6
4.0	Block diagram	p.10
5.0	Interface pin connection	p.11
6.0	Electrical characteristics	p.13
7.0	Reliability test items	p.20
8.0	Outline dimension	p.21
9.0	Lot mark	p.22
10.0	Package specification	p.23
11.0	General precaution	p.24

Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	4/25
Document No.		Revision	1.0

#### 1.0 GENERAL DESCRIPTION

#### 1.1 Introduction

HannStar Display model HSD070I651-F is a color active matrix thin film transistor (TFT) liquid crystal display (LCD) that uses amorphous silicon TFT as a switching device. This model is composed of a TFT LCD panel, a driving circuit and a back light system. This TFT LCD has a 7.0 (16:9) inch diagonally measured active display area with 1440 x 234 dot (480 horizontal by 234 vertical pixel) resolution.

#### 1.2 Features

- 7 (16:9 diagonal) inch configuration
- Compatible with NTSC & PAL system
- Image Reversion: UP/DOWN and LEFT/RIGHT
- RoHS Compliance

## 1.3 Applications

- Digital Photo frame
- Portable DVD
- Multimedia applications and Others AV system

#### 1.4 General information

Item		Specification	Unit
Outline Dimension	on	164.9 x 100 x 5.7 (Typ.)	mm
Display area		154.08(H) x 86.58(V)	mm
Number of Pixel		480 RGB(H) x234(V)	pixels
Pixel pitch		0.321(H) x 0.370(V)	mm
Pixel arrangeme	nt	RGB Vertical stripe	
Display mode		Normally white	
Surface treatment		Antiglare, Hard-Coating(3H) with EWV film	
Weight		160 (Typ.)	g
Back-light		Single LED (Side-Light type)	
Power Consumption	B/L System	1.2(Max.)	W

#### 1.5 Mechanical Information

	Item	Min.	Тур.	Max.	Unit
Modulo	Horizontal(H)	164.6	164.9	165.2	mm
Module Size	Vertical(V)	99.7	100.0	100.3	mm
Size	Depth(D)	_	5.7	6.0	mm
Weight (With	nout inverter)	_	160	_	g

Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	5/25
Document No.		Revision	1.0

# 2.0 ABSOLUTE MAXIMUM RATINGS

#### 2.1 Electrical Absolute Rating

## 2.1.1 TFT LCD Module(Absolute Maximum Rating)(1)

Item	Symbol	Min.	Max.	Unit	Note
Dower aupply voltage	$DV_DD$	-0.3	6.0	V	GND=0
Power supply voltage	$AV_DD$	-0.3	6.0	V	AGND=0
Analog Signal Input Level		-0.2	AV <sub>DD</sub> +0.2	V	
$V_{R,}V_{G,}V_{B}$		-0.2	AV <sub>DD</sub> +0.2	V	
Logic Signal Input Level		0.3	ר אין	V	
V <sub>I</sub>		-0.3	DV <sub>DD</sub> +0.3	V	

**Note:**(1) Stresses above those listed under "Absolute Maximum Rating" may cause permanent damage to the device. These are stress ratings only. Functional operation of this device at indicated in the operational sections(6.1) of this specification.

## 2.1.2 Back-Light Unit

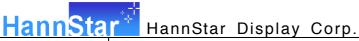
Item	Symbol	Тур.	Max.	Unit	Note
LED current	Ι <sub>L</sub>	100	_	mA	(1) (2)( <mark>3</mark> )
LED voltage	$V_{L}$	10.5	_	V	(1) (2)(3)

Note (1) Permanent damage may occur to the LCD module if beyond this specification. Functional operation should be restricted to the conditions described under normal operating conditions.

- (2) Ta =25±2°C
- (3) Test Condition: LED current 100 mA. The LED lifetime could be decreased if operating IL is larger than 100mA.

## 2.2 Environment Absolute Rating

Item	Symbol	Min.	Max.	Unit	Note
Operating Temperature	$T_{opa}$	-20	70	$^{\circ}\!\mathbb{C}$	
Storage Temperature	$T_{stg}$	-30	80	$^{\circ}\!\mathbb{C}$	



Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	6/25
Document No.		Revision	1.0

## 3.0 OPTICAL CHARACTERISTICS

## 3.1 Optical specification

Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Note
Contrast		CR		400	500	_		(1)(2)
Response	Rising	T <sub>R</sub>		_	5	7		(4) (0)
time	Falling	T <sub>F</sub>	⊖=0	_	20	28	msec	(1)(3)
White lumin (Center)	White luminance		Normal viewing	160	200	_	cd/m <sup>2</sup>	(1)(4) (I <sub>L</sub> =100mA)
Color		W <sub>x</sub>	angle	0.260	0.310	0.360		
chromaticity (CIE1931)	White	W <sub>y</sub>		0.280	0.330	0.380		
	Hor	θL		60	70	_		(1)(4)
Viewing	Hor.	$\Theta_{R}$		60	70	_		(1)(4)
angle	Man	θυ	CR>10	55	65	_		
	Ver.	θр		55	65	_		
Brightness uniformity		B <sub>UNI</sub>	⊖=0	70	75	_	%	(5)
Optima View	Direction		6 O' clock					

## 3.2 Measuring Condition

■ Measuring surrounding: dark room

■ LED current I<sub>L</sub>: 100mA

■ Ambient temperature: 25±2°C

■ 15min. warm-up time.

## 3.3 Measuring Equipment

■ FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.

■ Measuring spot size : 20 ~ 21 mm

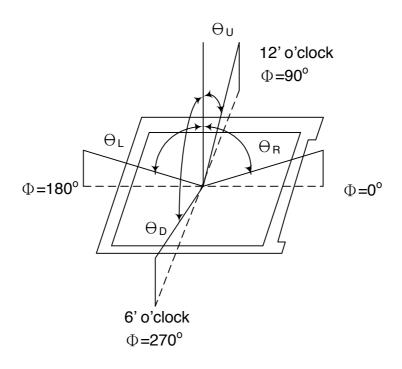


**Document Title** 

Document No.

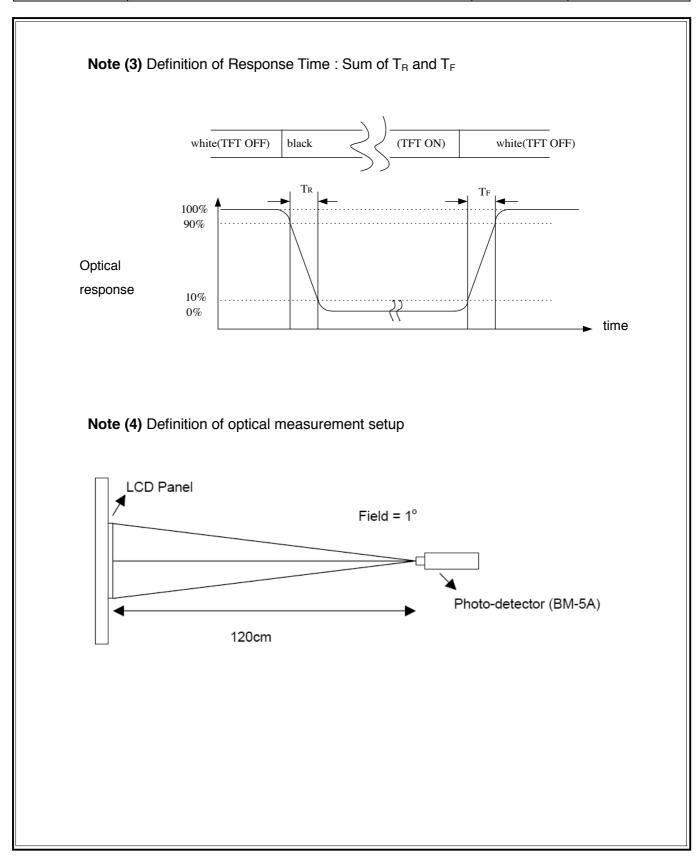
Hannstar Display Corp.		
HSD070I651-F01 CAS for Chinachip	Page No.	7/25
	Revision	1.0

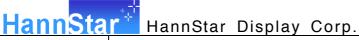
Note (1) Definition of Viewing Angle:



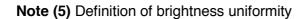
**Note (2)** Definition of Contrast Ratio(CR) : measured at the center point of panel

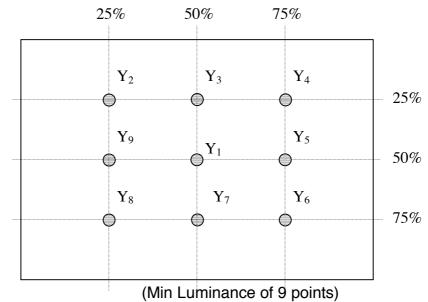
Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	8/25
Document No.		Revision	1.0





Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	9/25
Document No.		Revision	1.0

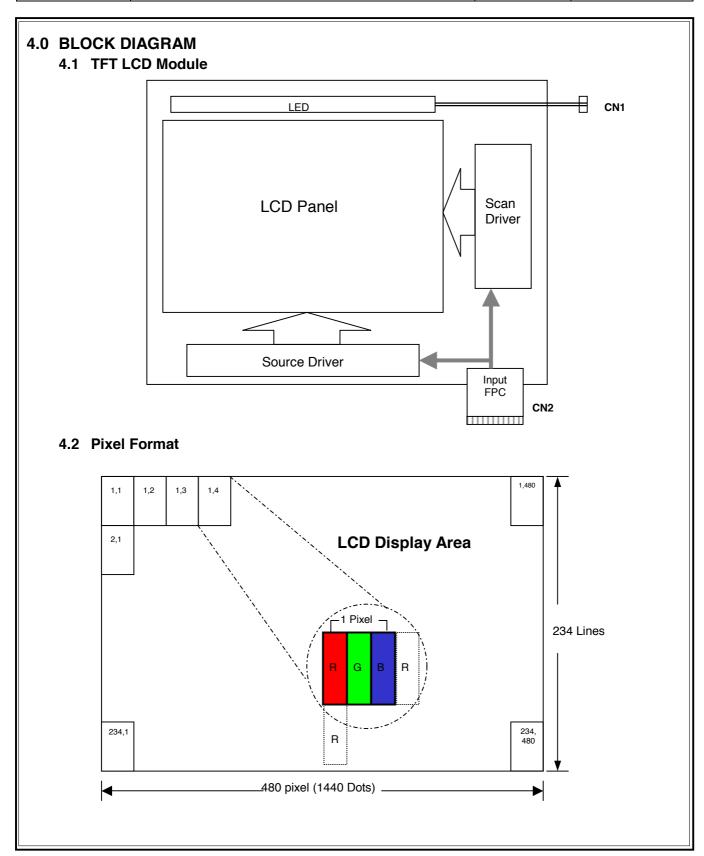




 $\label{eq:Luminance uniformity} = \frac{}{\text{(Max Luminance of 9 points)}} \times 100\%$ 

**Note (6)** Rubbing Direction (The different Rubbing Direction will cause the different optima view direction.

Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	10/25
Document No.		Revision	1.0



Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	11/25
Document No.		Revision	1.0

#### 5.0 INTERFACE PIN CONNECTION

#### 5.1 TFT LCD Module

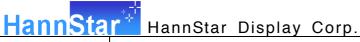
CN2 (Input signal): FPC Down Connector, 26 pins, pitch: 0.5mm

Terminal no.	Symbol	I/O	Function	Note
1	DGND	-	Ground for logic circuit	
2	$DV_DD$	ı	Supply voltage of logic control circuit for scan (Gate) driver	
3	V <sub>GL</sub>	ı	Negative power for scan (Gate) driver	
4	V <sub>GH</sub>	ı	Positive power for scan (Gate) driver	
5	STVD	I/O	Vertical start pulse	(1)
6	STVU	I/O	Vertical start pulse	(1)
7	CKV	- 1	Shift clock input for scan (Gate) driver	
8	U/D	ı	UP/DOWN scan control input	(1)
9	OEV	ı	Output enable input for scan(Gate) driver	
10	Vсом	- 1	Common electrode driving signal	
11	Vсом	ı	Common electrode driving signal	
12	L/R	ı	LEFT/RIGHT scan control input	(1)
13	MOD	- [	Sequential sampling and simultaneous sampling setting	(2)
14	OEH	- 1	Output enable input for data (Source) driver	
15	STHL	I/O	Start pulse for horizontal scan (Gate) line	(1)
16	STHR	I/O	Start pulse for horizontal scan (Gate) line	(1)
17	CPH3	I	Sampling and shifting clock pulse for data (Source) driver	(2)
18	CPH2	I	Sampling and shifting clock pulse for data (Source) driver	(2)
19	CPH1	-	Sampling and shifting clock pulse for data (Source) driver	
20	$DV_DD$	I	Supply voltage of logic control circuit for data(Source) driver	
21	DGND	-	Ground for logic circuit	
22	$V_{R}$	I	Alternated video signal input(Red)	
23	<b>V</b> G	-	Alternated video signal input(Green)	
24	<b>V</b> B	1	Alternated video signal input(blue)	
25	$AV_DD$	I	Supply voltage for analog circuit	
26	AGND	-	Ground for analog circuit	

Note (1) Selection of scanning mode (please refer to the following table)

Setting of s	Setting of scan control input		IN/OUT state for start pulse		pulse	Scanning direction
U/D	L/R	STVD	STVU	STHR	STHL	
GND	DV <sub>DD</sub>	Output	Input	Output	Input	up to down, and from left to right.
DV <sub>DD</sub>	GND	Input	Output	Input	Output	down to up, and from right to left.
GND	GND	Output	Input	Input	Output	up to down, and from right to left.
DV <sub>DD</sub>	DV <sub>DD</sub>	Input	Output	Output	Input	down to up, and from left to right.

Note (2) MOD=H: Simultaneous sampling.(Please check CPH2 and CPH3 to GND when MOD=H) MOD=L: Sequential sampling.

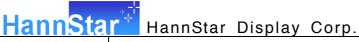


Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	12/25
Document No.		Revision	1.0

# 5.2 Back-Light Unit

**CN1** LED Power Source (**BHSR-02VS-1**) / JAPAN SOLDERLESS TERMINAL MFG CO., LTD. Mating Connector: (**SBHT-002T-P0.5**) / JAPAN SOLDERLESS TERMINAL MFG CO., LTD.

,	,	•
Terminal no.	Symbol	Function
1	VL	LED power supply (high voltage)
2	GL	LED power supply (low voltage)



Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	13/25
Document No.		Revision	1.0

## 6.0 ELECTRICAL CHARACTERISTICS

## 6.1 TFT LCD Module (Operation Rating)

Item	Symbol	Min.	Тур.	Max.	Unit	Note
	$DV_{DD}$	2.7	3.3	5.5	V	
Supply Voltage	<b>V</b> GH	14.3	15	15.7	V	
Supply Voltage	V <sub>GL</sub>	-10.5	-10	-9.5	V	
	$AV_{DD}$	3	-	5.5	V	
Video signal	ViA	0.4	-	AV <sub>DD</sub> -0.4	V	
amplitude	Viac	-	4	-	V	AC component,
(VR,VG,VB)	ViDC	-	AV <sub>DD</sub> /2	-	V	DC component
VCOM	VCAC		5.5		Vp-p	AC component
VCOIVI	Vcdc	1.6	1.8	2.0	V	DC component, (1)
Input signal	$V_{iH}$	0.7DV <sub>DD</sub>	-	DV <sub>DD</sub>	V	(2)
voltage	$V_{iL}$	0		0.3DV <sub>DD</sub>	V	(2)
	IDD	-	4.2	-	mA	$DV_{DD} = 3.3V$
Current of power	ladd	-	3.7	-	mA	AV <sub>DD</sub> =5V(Black)
supply	lgн	-	60	-	uA	V <sub>GH</sub> =15V
	<b>I</b> GL	-	400	-	uA	V <sub>GL</sub> =-10V

Note (1): The brightness of LCD panel could be changed by adjusting the AC component of VCOM.

Note (2): STHL, STHR, OEH, L/R, CPH1~CPH3, STVD, STVU, OEV, CKV, U/D

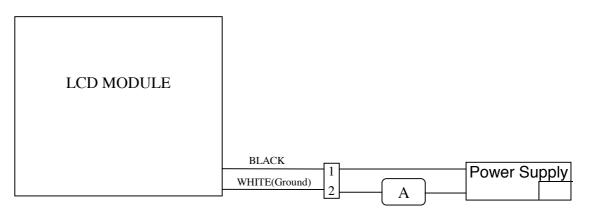
Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	14/25
Document No.		Revision	1.0

#### 6.2 Back-Light Unit

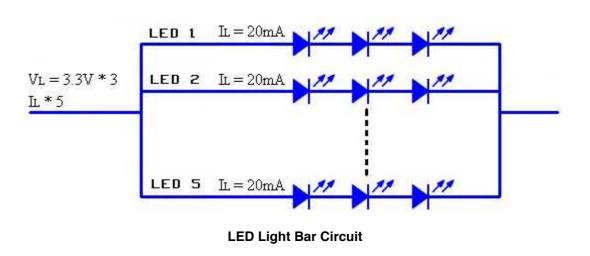
The back-light system is an edge-lighting type with 15 LED.

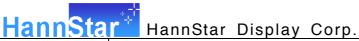
The characteristic of the LED is shown in the following tables.

Item	Symbol	Min.	Тур.	Max.	Unit	Note
LED current	IL	-	100	_	mA	(2)
LED voltage	VL	-	10.5	_	V	
Operating LED life time	Hr	20,000	-	_	Hour	(1)(2)

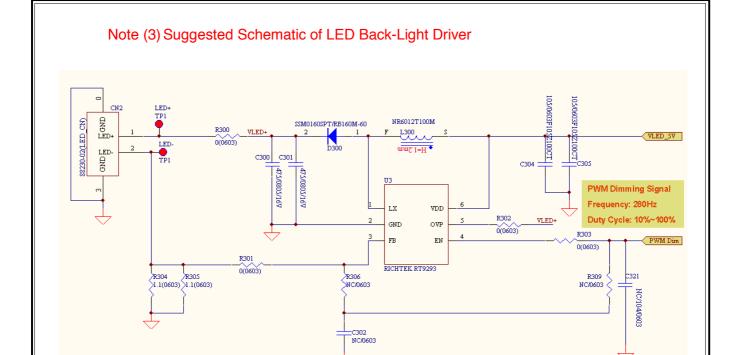


- Note (1) LED life time (Hr) can be defined as the time in which it continues to operate under the condition: Ta=25±3 °C, typical IL value indicated in the above table until the brightness becomes less than 50%.
- Note (2) The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and IL=100mA. The LED lifetime could be decreased if operating IL is larger than 100mA. The constant current driving method is suggested.

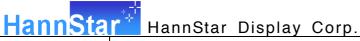




Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	15/25
Document No.		Revision	1.0



**Suggested Schematic of LED Back-Light Driver** 



Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	16/25
Document No.		Revision	1.0

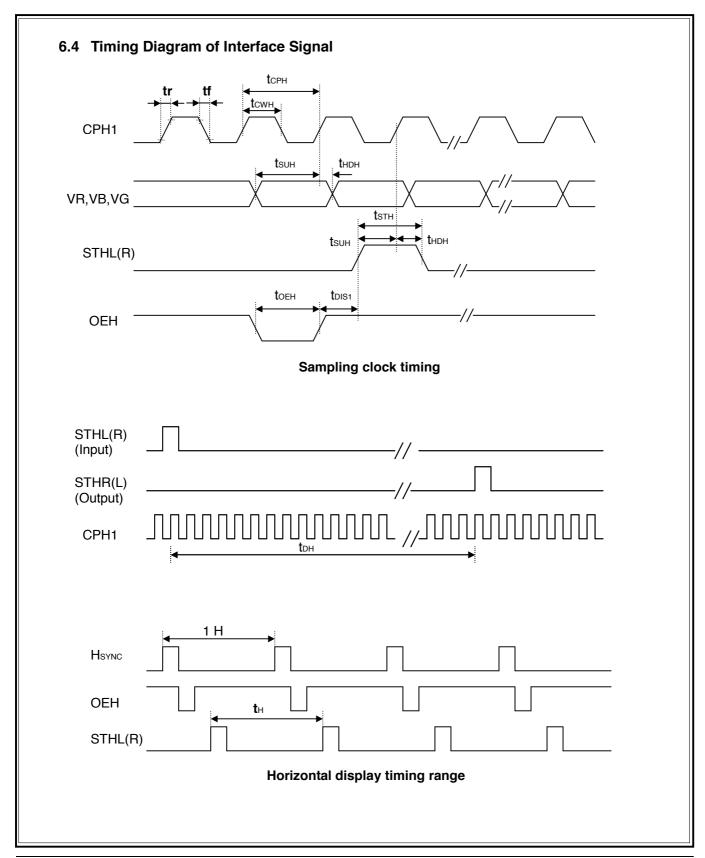
## 6.3 AC Characteristics

Item	Symbo I	Min.	Тур.	Max.	Unit	Note
Rising time	tr	-	-	10	ns	(1)
Falling time	tf	-	-	10	ns	(1)
High and low level pulse duty	<b>t</b> CPH	100	103	-	ns	CPH1~CPH3
CPH pulse duty	tсwн	40	50	60		CPH1~CPH3
STH setup time	<b>t</b> sun	20	-	-	ns	STHR,STHL
STH hold time	<b>t</b> HDH	10	-	-	ns	STHR,STHL
STH pulse width	<b>t</b> sтн	-	1	-	<b>t</b> CPH	STHR,STHL
STH period	tн	61.5	63.5	65.5	μs	STHR,STHL
OEH pulse width	<b>t</b> oeh	-	1.23	-	μs	OEH
Sample and hold disable time	<b>t</b> DIS1	-	8.19	-	μs	
OEV pulse width	toev	-	4.77	-	μs	OEV
CKV pulse width	<b>t</b> ckv	-	3.91	-	μs	CKV
Clean enable time	tDIS2	-	3.90	-	μs	
Horizontal display timing range	<b>t</b> DH	-	1440	-	tсрн/3	
STV setup time	<b>t</b> suv	200	-	-	ns	STVD,STVU
STV hold time	<b>t</b> hdv	300	-	-	ns	STVD,STVU
STV pulse width	<b>t</b> stv	-	1	-	<b>t</b> н	STVD,STVU
Horizontal line per field	tv	256	262	268	<b>t</b> н	(2)
Vertical display start	tsv		3	-	<b>t</b> н	
Vertical display timing range	tov		234	-	tн	
VCOM Rising time	trсом		-	5	μs	
VCOM Falling time	<b>t</b> fCOM		-	5	μs	
VCOM delay time	tосом		-	3	μs	
RGB delay time	<b>t</b> DRGB		*	1	μs	

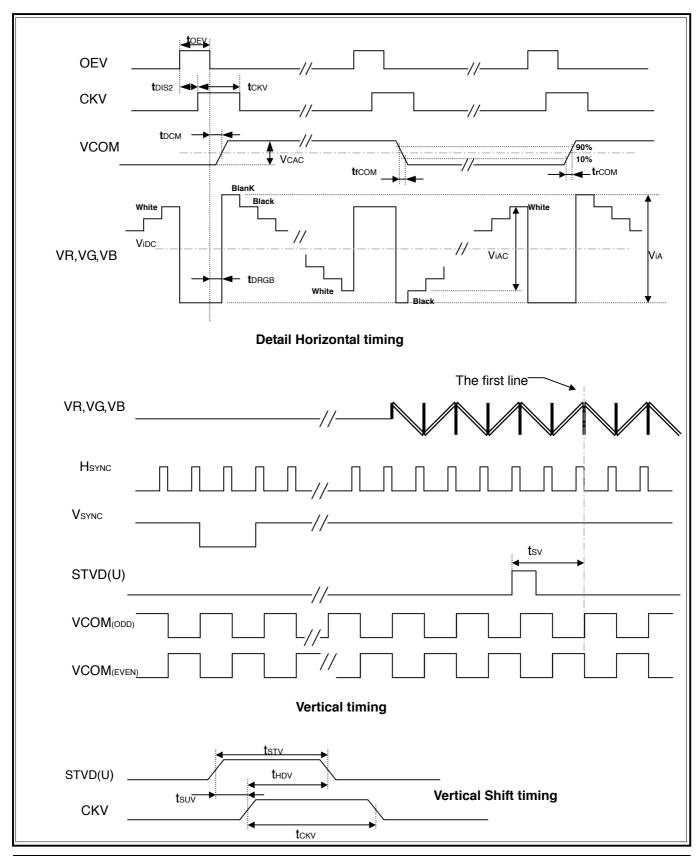
Note (1): For all of the logic signals.

Note (2): Please don't use odd horizontal lines to drive LCD panel for both odd and even filed simultaneously.

Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	17/25
Document No.		Revision	1.0



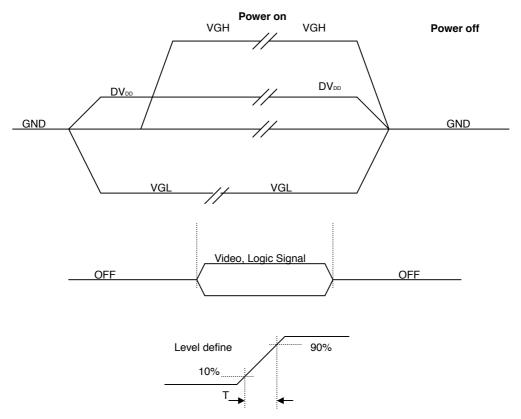
Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	18/25
Document No.		Revision	1.0





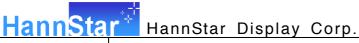
Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	19/25
Document No.		Revision	1.0





Power Sequence: DVDD -> VGL -> VGH

Note Apply the LED volatge within the LCD operation range. When the back-light turns on before the LCD operation or the LCD truns off before the back-light turns off. the display may momentarily become white.



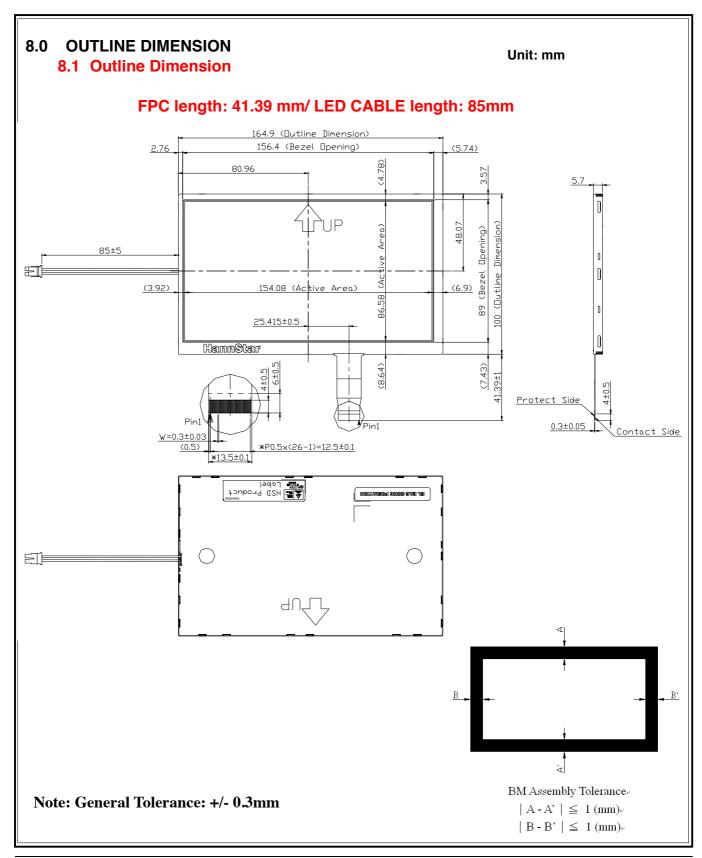
Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	20/25
Document No.		Revision	1.0

# 7.0 Reliability test items

No.	Item	Conditions	Remark
1	High Temperature Storage	Ta=+80°C, 240hrs	
2	Low Temperature Storage	Ta=-30°C, 240hrs	
3	High Temperature Operation	Ta=+70°C, 240hrs	
4	Low Temperature Operation	Ta=-20°C, 240hrs	
5	High Temperature and High Humidity (operation)	Ta=+60°C, 90%RH, 240hrs	
6	Thermal Cycling Test (non operation)	$-30^{\circ}\text{C}(30\text{min}) \rightarrow +80^{\circ}\text{C}(30\text{min}), 200\text{cycles}$	
7	Electrostatic Discharge	$\pm 200\text{V}, 200\text{pF}(0\Omega)$ 1 time/each terminal	
8	Vibration	1.Random: 1.04Grms, 10~500Hz, X/Y/Z, 30min/each direction	
		2.Sweep sine: 1.5G, 5~500Hz, X/Y/Z, 30min/each direction	
9	Shock	100G,6ms, ±X, ±Y, ±Z 3 time for each direction	JIS C7021, A-10 (Condition A)
10	Vibration (with carton)	Random:  1.04Grms, 10~500Hz, X/Y/Z 45min/each direction  Fixed:  5Hz, 1.5Grms, X/Y/Z 45min/each direction	
11	Drop (with carton)	Height: 60cm 1 corner, 3 edges, 6 surfaces	JIS Z0202

Note: There is no display function NG issue occurred, all the cosmetic specification is judged before the reliability stress.

Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	21/25
Document No.		Revision	1.0



HannStar HannStar Display Corp.

Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	22/25
Document No.		Revision	1.0

# 9.0 LOT MARK 9.1 Lot Mark



code 1,2,3,4,5,6: HannStar internal flow control code.

code 7: production location.

code 8: production year.

code 9: production month.

code 10,11,12,13,14,15: serial number.

#### Note (1) Production Year

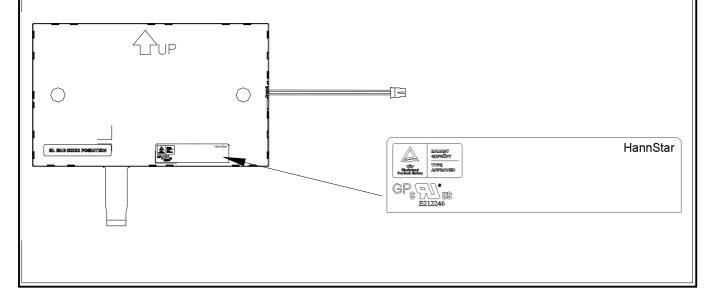
Year	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008
Mark	9	0	1	2	3	4	5	6	7	8

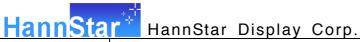
#### Note (2) Production Month

	Month	Jan.	Feb.	Mar.	Apr.	May.	Jun.	Jul.	Aug.	Sep.	Oct	Nov.	Dec.
•	Mark	1	2	3	4	5	6	7	8	9	Α	В	С

#### 9.2 Location of Lot Mark

- (1) The label is attached to the backside of the LCD module.
- (2) This is subject to change without prior notice.





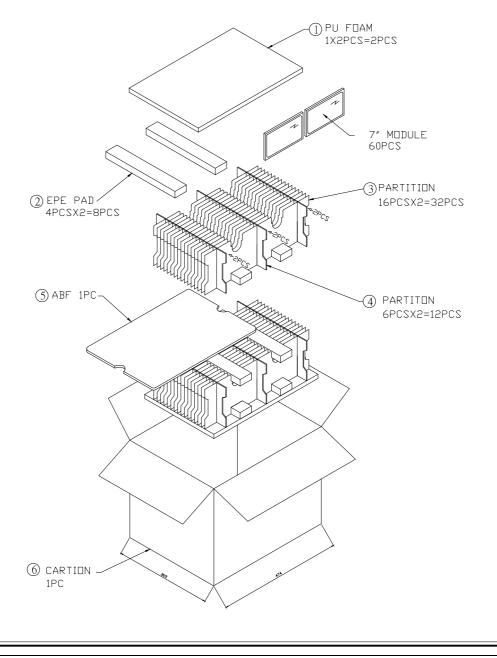
Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	23/25
Document No.		Revision	1.0

# 10.0 PACKAGE SPECIFICATION

## 10.1 Packing form

- (1) Package quantity in one carton: 60 pieces.
- (2) Carton size: 464±5 mm×360±5 mm×370±5 mm.

# 10.2 Packing assembly drawings



Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	24/25
Document No.		Revision	1.0

## 11.0 GENERAL PRECAUTION

#### 11.1 Use Restriction

This product is not authorized for use in life supporting systems, aircraft navigation control systems, military systems and any other application where performance failure could be life threatening or otherwise catastrophic.

## 11.2 Disassembling or Modification

Do not disassemble or modify the module. It may damage sensitive parts inside LCD module, and may cause scratches or dust on the display. HannStar does not warrant the module, if customers disassemble or modify the module.

#### 11.3 Breakage of LCD Panel

- 11.3.1.If LCD panel is broken and liquid crystal spills out, do not ingest or inhale liquid crystal, and do not contact liquid crystal with skin.
- 11.3.2. If liquid crystal contacts mouth or eyes, rinse out with water immediately.
- 11.3.3. If liquid crystal contacts skin or cloths, wash it off immediately with alcohol and rinse thoroughly with water.
- 11.3.4. Handle carefully with chips of glass that may cause injury, when the glass is broken.

#### 11.4 Electric Shock

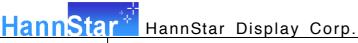
- 11.4.1. Disconnect power supply before handling LCD module.
- 11.4.2. Do not pull or fold the LED cable.
- 11.4.3. Do not touch the parts inside LCD modules and the fluorescent LED's connector or cables in order to prevent electric shock.

## 11.5 Absolute Maximum Ratings and Power Protection Circuit

- 11.5.1. Do not exceed the absolute maximum rating values, such as the supply voltage variation, input voltage variation, variation in parts' parameters, environmental temperature, etc., otherwise LCD module may be damaged.
- 11.5.2. Please do not leave LCD module in the environment of high humidity and high temperature for a long time.
- 11.5.3. It's recommended to employ protection circuit for power supply.

#### 11.6 Operation

- 11.6.1 Do not touch, push or rub the polarizer with anything harder than HB pencil lead.
- 11.6.2 Use fingerstalls of soft gloves in order to keep clean display quality, when persons handle the LCD module for incoming inspection or assembly.
- 11.6.3 When the surface is dusty, please wipe gently with absorbent cotton or other soft material.



Document Title	HSD070I651-F01 CAS for Chinachip	Page No.	25/25
Document No.		Revision	1.0

- 11.6.4 Wipe off saliva or water drops as soon as possible. If saliva or water drops contact with polarizer for a long time, they may causes deformation or color fading.
- 11.6.5 When cleaning the adhesives, please use absorbent cotton wetted with a little petroleum benzine or other adequate solvent.

#### 11.7 Static Electricity

- 11.8.1 Protection film must remove very slowly from the surface of LCD module to prevent from electrostatic occurrence.
- 11.8.2. Because LCD module use CMOS-IC on circuit board and TFT-LCD panel, it is very weak to electrostatic discharge. Please be careful with electrostatic discharge. Persons who handle the module should be grounded through adequate methods.

## 11.8 Strong Light Exposure

The module shall not be exposed under strong light such as direct sunlight. Otherwise, display characteristics may be changed.

# 11.9Disposal

When disposing LCD module, obey the local environmental regulations.